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# **TTM Technologies, Inc. Awarded Nadcap Accreditation for Aerospace Quality**

## **Second TTM Asia Pacific Site to Meet Nadcap Standards**

SANTA ANA, Calif., May 3, 2011 (GLOBE NEWSWIRE) -- TTM Technologies, Inc. (Nasdaq:TTMI) announced that its Guangzhou facility ("GME") has received the Nadcap accreditation for electronics manufactured for the aerospace industry. GME was first certified with AS9100B in June 2010. This accreditation further demonstrates TTM's commitment to continuous improvement in aerospace quality and dedication to meet customer requirements according to industry specifications.

Kent Alder, President and CEO of TTM, noted, "This is another significant milestone for us as we commit to continuously improve our processing systems with better reliability and traceability for the aerospace industry. We commend our team in Guangzhou for achieving this important goal efficiently and ahead of schedule. The transfer of best practices from our other accredited plants also helped make this possible." Alder concluded, "Having a second site in China awarded with the Nadcap accreditation is part of a focused effort to better serve the commercial aerospace industry on a global basis."

TTM now has three facilities in North America and two facilities in Asia Pacific with AS9100 and Nadcap certifications.

The Nadcap program, as a part of PRI (Performance Review Institute), was created in 1990 by the Society of Automotive Engineers and is headquartered in Warrendale, Pennsylvania. Nadcap's membership of "prime contractors" convenes to coordinate industry-wide standards for special processes and products. Through PRI, Nadcap provides independent certification of manufacturing processes for the industry. PRI's mission is to "provide international, unbiased, independent manufacturing process and product assessments and certification services for the purpose of adding value, reducing total cost, and facilitating relationships between primes and suppliers."

### **Safe Harbor Statement**

This release contains forward-looking statements that relate to future events or performance. These statements reflect the company's current expectations, and the company does not undertake to update or revise these forward-looking statements, even if experience or future changes make it clear that any projected results expressed or implied in this or other company statements will not be realized. Furthermore, readers are cautioned that these statements involve risks and uncertainties, many of which are beyond the company's control, which could cause actual results to differ materially from the forward-looking statements.

These risks and uncertainties include, but are not limited to, the company's dependence upon the electronics industry, the impact of the current economic crisis, the company's dependence upon a small number of customers, the unpredictability of and potential fluctuation in future revenues and operating results, increased competition from low-cost foreign manufacturers and other "Risk Factors" set forth in the company's most recent SEC filings.

About TTM Technologies, Inc.

TTM Technologies, Inc. is a major global printed circuit board manufacturer, focusing on quick-turn and technologically advanced PCBs and the backplane and sub-system assembly business. TTM stands for time-to-market, representing how the company's time-critical, one-stop manufacturing services enable customers to shorten the time required to develop new products and bring them to market. Additional information can be found at [www.ttmtech.com](http://www.ttmtech.com).

The TTM Technologies logo is available at <https://www.globenewswire.com/newsroom/prs/?pkgid=5691>

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